16.480/552

- Course web
 - <u>http://yanluo.github.io/teaching/16.480.552/</u>
- Course discussion forum
 - We use the web based forum on piazza.com (please search the course number 16.480)
- Lectures and lab sessions
 - mandatory
- Lab assignments, reports, and demo
 - Hardware/software design, debugging, testing
- Exams
 - Two in-class 90-minute exams
- Grading
 - Labs-60%, Exams-40%,
 - 16.480 and 16.552 graded in separate scale

Introduction to Embedded Systems

Prof. Yan Luo

For UMass Lowell 16.480/552

Outline

- Overview of Embedded Systems
- Design Challenges
- Design methodology
- Embedded processors
- Numbering system

Embedded systems overview

- Computing systems are everywhere
- Most of us think of "desktop" computers
 - PC's



- Laptops
- Mainframes
- Servers
- But there's another type of computing system
 - Far more common...

Acknowledgement: Slides 4-36 are based on "Embedded Systems Design: A Unified Hardware/ Software" by Vahid/Givargis

Embedded systems overview

- Embedded computing systems
 - Computing systems embedded within electronic devices
 - Hard to define. Nearly any computing system other than a desktop computer
 - Billions of units produced yearly, versus millions of desktop units
 - Perhaps 50 per household and per automobile

Computers are in here	
and here	6
and even here	
Contraction Contraction	Conner Anner
HUNDER MUNICE MUNICE	Connel Connel Connel

Lots more of these, though they cost a lot less each.

A "short list" of embedded systems

Anti-lock brakes Auto-focus cameras Automatic teller machines Automatic toll systems Automatic transmission Avionic systems Battery chargers Camcorders Cell phones Cell-phone base stations Cordless phones Cruise control Curbside check-in systems Digital cameras Disk drives Electronic card readers Electronic instruments Electronic toys/games Factory control Fax machines **Fingerprint identifiers** Home security systems Life-support systems Medical testing systems

Modems MPEG decoders Network cards Network switches/routers **On-board navigation** Pagers Photocopiers Point-of-sale systems Portable video games Printers Satellite phones Scanners Smart ovens/dishwashers Speech recognizers Stereo systems **Teleconferencing systems** Televisions **Temperature controllers** Theft tracking systems TV set-top boxes VCR's, DVD players Video game consoles Video phones Washers and dryers























And the list goes on and on

Some common characteristics of embedded systems

- Single-functioned
 - Executes a single program, repeatedly
- Tightly-constrained
 - Low cost, low power, small, fast, etc.
- Reactive and real-time
 - Continually reacts to changes in the system's environment
 - Must compute certain results in real-time without delay

An embedded system example -- a digital camera



- Single-functioned -- always a digital camera
- Tightly-constrained -- Low cost, low power, small, fast
- Reactive and real-time -- only to a small extent

Design challenge – optimizing design metrics

- Obvious design goal:
 - Construct an implementation with desired functionality
- Key design challenge:

- Simultaneously optimize numerous design metrics

- Design metric
 - A measurable feature of a system's implementation
 - Optimizing design metrics is a key challenge

Design challenge – optimizing design metrics

- Common metrics
 - Unit cost: the monetary cost of manufacturing each copy of the system, excluding NRE cost
 - NRE cost (Non-Recurring Engineering cost): The onetime monetary cost of designing the system
 - Size: the physical space required by the system
 - Performance: the execution time or throughput of the system
 - Power: the amount of power consumed by the system
 - Flexibility: the ability to change the functionality of the system without incurring heavy NRE cost

Design challenge – optimizing design metrics

- Common metrics (continued)
 - Time-to-prototype: the time needed to build a working version of the system
 - Time-to-market: the time required to develop a system to the point that it can be released and sold to customers
 - Maintainability: the ability to modify the system after its initial release
 - Correctness, safety, many more

Design metric competition -improving one may worsen others





- Expertise with both
 software and hardware is
 needed to optimize design
 metrics
 - Not just a hardware or software expert, as is common
 - A designer must be comfortable with various technologies in order to choose the best for a given application and constraints

Software

Time-to-market: a demanding design metric



- Time required to develop a product to the point it can be sold to customers
- Market window
 - Period during which the product would have highest sales
- Average time-to-market constraint is about 8 months
- Delays can be costly

Losses due to delayed market entry



- Simplified revenue model
 - Product life = 2W, peak at W
 - Time of market entry defines a triangle, representing market penetration
 - Triangle area equals revenue
- Loss
 - The difference between the on-time and delayed triangle areas

Losses due to delayed market entry (cont.)



- Area = 1/2 * base * height
 - On-time = 1/2 * 2W * W
 - Delayed = 1/2 * (W-D+W)*(W-D)
- Percentage revenue loss = (D(3W-D)/2W²)*100%
- Try some examples
 - Lifetime 2W=52 wks, delay D=4 wks
 - $(4^*(3^*26 4)/2^*26^2) = 22\%$
 - Lifetime 2W=52 wks, delay D=10 wks
 - $-(10^*(3^*26-10)/2^*26^2)=50\%$
 - Delays are costly!

NRE and unit cost metrics

- Costs:
 - Unit cost: the monetary cost of manufacturing each copy of the system, excluding NRE cost
 - NRE cost (Non-Recurring Engineering cost): The one-time monetary cost of designing the system
 - total cost = NRE cost + unit cost * # of units
 - per-product cost = total cost / # of units
 - = (NRE cost / # of units) + unit cost
- Example
 - NRE=\$2000, unit=\$100
 - For 10 units
 - total cost = \$2000 + 10*\$100 = \$3000
 - per-product cost = $\frac{2000}{10} + 100 = 300$

Amortizing NRE cost over the units results in an additional \$200 per unit

NRE and unit cost metrics

- Compare technologies by costs -- best depends on quantity
 - Technology A: NRE=\$2,000, unit=\$100
 - Technology B: NRE=\$30,000, unit=\$30
 - Technology C: NRE=\$100,000, unit=\$2



• But, must also consider time-to-market

The performance design metric

- Widely-used measure of system, widely-abused
 - Clock frequency, instructions per second not good measures
 - Digital camera example a user cares about how fast it processes images, not clock speed or instructions per second
- Latency (response time)
 - Time between task start and end
 - e.g., Camera's A and B process images in 0.25 seconds
- Throughput
 - Tasks per second, e.g. Camera A processes 4 images per second
 - Throughput can be more than latency seems to imply due to concurrency, e.g. Camera B may process 8 images per second (by capturing a new image while previous image is being stored).
- *Speedup* of B over S = B's performance / A's performance
 - Throughput speedup = 8/4 = 2

Three key embedded system technologies

- Technology
 - A manner of accomplishing a task, especially using technical processes, methods, or knowledge
- Three key technologies for embedded systems
 - Processor technology
 - IC technology
 - Design technology

Processor technology

- The architecture of the computation engine used to implement a system's desired functionality
- Processor does not have to be programmable
 - "Processor" not equal to general-purpose processor



Processor technology

• Processors vary in their customization for the problem at hand



General-purpose processors

- Programmable device used in a variety of applications
 - Also known as "microprocessor"
- Features
 - Program memory
 - General datapath with large register file and general ALU
- User benefits
 - Low time-to-market and NRE costs
 - High flexibility
- "Pentium" the most well-known, but there are hundreds of others



Single-purpose processors

- Digital circuit designed to execute exactly one program
 - a.k.a. coprocessor, accelerator or peripheral
- Features
 - Contains only the components needed to execute a single program
 - No program memory
- Benefits
 - Fast
 - Low power
 - Small size

Controller	Datapath
Control logic State register	index total +
	Data memory

Application-specific processors

- Programmable processor optimized for a particular class of applications having common characteristics
 - Compromise between general-purpose and single-purpose processors
- Features
 - Program memory
 - Optimized datapath
 - Special functional units
- Benefits
 - Some flexibility, good performance, size and power



IC technology

- The manner in which a digital (gate-level) implementation is mapped onto an IC
 - IC: Integrated circuit, or "chip"
 - IC technologies differ in their customization to a design
 - IC's consist of numerous layers (perhaps 10 or more)
 - IC technologies differ with respect to who builds each layer and when



IC technology

- Three types of IC technologies
 - Full-custom/VLSI
 - Semi-custom ASIC (gate array and standard cell)
 - PLD (Programmable Logic Device)

Full-custom/VLSI

- All layers are optimized for an embedded system's particular digital implementation
 - Placing transistors
 - Sizing transistors
 - Routing wires
- Benefits
 - Excellent performance, small size, low power
- Drawbacks
 - High NRE cost (e.g., \$300k), long time-to-market

Semi-custom

- Lower layers are fully or partially built
 - Designers are left with routing of wires and maybe placing some blocks
- Benefits
 - Good performance, good size, less NRE cost than a full-custom implementation (perhaps \$10k to \$100k)
- Drawbacks

- Still require weeks to months to develop

PLD (Programmable Logic Device)

- All layers already exist
 - Designers can purchase an IC
 - Connections on the IC are either created or destroyed to implement desired functionality
 - Field-Programmable Gate Array (FPGA) very popular
- Benefits
 - Low NRE costs, almost instant IC availability
- Drawbacks
 - Bigger, expensive (perhaps \$30 per unit), power hungry, slower

Moore's law

- The most important trend in embedded systems
 - Predicted in 1965 by Intel co-founder Gordon Moore
 <u>IC transistor capacity has doubled roughly every 18 months for the past several decades</u>



The Future of Moore's law

- Does Moore's Law still hold?
 - This growth rate has been steady until ~2005
 - Factors limiting transistor counts
 - Power consumption (leakage power)
 - Temperature
 - Development of new technology (65nm, 45nm, 30nm...)
 - Transistor density growth slows down
- New Trend
 - Multiple computing cores
 - Not significant higher frequency
 - Nanotechnology

The co-design ladder

- In the past:
 - Hardware and software design technologies were very different
 - Recent maturation of synthesis enables a unified view of hardware and software
- Hardware/software "codesign"



The choice of hardware versus software for a particular function is simply a tradeoff among various design metrics, like performance, power, size, NRE cost, and especially flexibility; there is no fundamental difference between what hardware or software can implement.

Independence of processor and IC technologies

- Basic tradeoff
 - General vs. custom
 - With respect to processor technology or IC technology
 - The two technologies are independent



Design productivity gap

 While designer productivity has grown at an impressive rate over the past decades, the rate of improvement has not kept pace with chip capacity



Design productivity gap

- 1981 leading edge chip required 100 designer months
 - 10,000 transistors / 100 transistors/month
- 2002 leading edge chip requires 30,000 designer months
 - 150,000,000 / 5000 transistors/month
- Designer cost increase from \$1M to \$300M



The mythical man-month

- The situation is even worse than the productivity gap indicates
- In theory, adding designers to team reduces project completion time
- In reality, productivity per designer decreases due to complexities of team management and communication
- In the software community, known as "the mythical man-month" (Brooks 1975)
- At some point, can actually lengthen project completion time! ("Too many cooks")
 - 1M transistors, 1 designer=5000 trans/month
 - Each additional designer reduces for 100 trans/month
 - So 2 designers produce 4900 trans/month each



Embedded Processors

- Requirements for embedded processors
 - Low power consumption
 - Programmable
 - Low cost
- Examples
 - Microcontroller-type:
 - self-contained (mem, I/O, ADC, etc.), GPIO,
 - no OS, less interactive environment e.g. sensor data acquisition
 - Microchip PIC, Intel 8051, Parallex Propeller, Atmel AVR, TI MSP430
 - Microprocessor-type:
 - SoC, demux address/data buses, co-processor, standard system buses
 - often with OS, more interactive environment e.g. set-top box, invehicle entertainment system
 - Intel Atom/Quark, TI OMAP4, Nvidia Tegra, Apple A8

PIC16F684







FIGURE 1-1:

PIC18F2XK20 (28-PIN) BLOCK DIAGRAM







Source: https://learn.sparkfun.com/tutorials/galileo-getting-started-guide

Summary

- Embedded systems are everywhere
- Key challenge: optimization of design metrics
 - Design metrics compete with one another
- A unified view of hardware and software is necessary to improve productivity
- Three key technologies
 - Processor: general-purpose, application-specific, single-purpose
 - IC: Full-custom, semi-custom, PLD, Moore's Law
 - Design: hw/sw co-design, design productivity
- Embedded Processors: architecture and applications